ABSOCIATION CONNECTING ELECTRONICS INDUSTRIES® INDUSTRIES®	kburn, Illinois. All rights reserv	ed under both This docu	ment is a declara s, the declaration	tion of the substance encompasses all low	es within the manufactur ver level materials for wl	er listed item. Note: hich the manufactur	if the item is an a rer has engineering	ssembly with lower responsibility.		
IPC Web Site for Information or http://www.ipc.org/IPC-175x	IPC-1752 Standard	Form Type * Distribute	Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Information							
Supplier Information										
Company name*	name* Company unique ID		Unique ID Authority			Response Date*				
onsemi						2024-05-21				
Contact Name	Title - Contact		Phone - Contact*			Email - Contact*				
Product-Env-Stewards	Product Enviro Compliance		NA			Product-Env-Stewards@onsemi.com				
Authorized Representative*	tive* Title - Representative		Phone - Representative*			Email - Representative*				
Product-Env-Stewards Product Enviro Comp		Compliance N		NA			Product-Env-Stewards@onsemi.com			
Requester Item Number Mfr Ite	m Number Mfr Item Nar	Mfr Item Name		e Version	Manufacturing Site	Weight*	UOM	Unit Type		
NCV8	402AMNWT1G 165mOhm, 2.	A low-side SmartFET in DFN	2024-05-21 MY1		MY1	23.43	mg	Each		
Manufacturing Proccess Information										
Terminal Plating / Grid Array Material	Terminal Base Alloy	J-STD-020 MSL Rating	Peak Pro	cess Body Temperat	ture Max Time at Peak	Temperature Nun	nber of Reflow Cy	cles		
Matte Tin (Sn) - annealed CU Alloy 1		1	260	С	30	seconds 3				
Comments										
level 1 - maximum time at peak temperature during s	oldering is 10-30 seconds									
For more information regarding material compositio	n please refer to page 3									

RoHS Material Composition Declaration				Declaration Type *	Detailed			
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).							
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of			
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted			
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all			
Exemption List Version	EL-2011/534/EU							
Declaration Signature								
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the			
Supplier Digital Signature Ra	stislav Drska	Le						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	1.21	mg	Supplier	Silicon (Si)	7440-21-3		1.21	mg
Die Attach	0.4	mg	Supplier	Isobornyl Methacrylate	7534-94-3		0.024	mg
			Supplier	Silver (Ag)	7440-22-4		0.326	mg
			Supplier	Isobornyl Acrylate	5888-33-5		0.024	mg
			Supplier	Misc.	Proprietary Data		0.002	mg
			Supplier	Tricyclo[5.2.1.02,6]decanedimethanol Diacrylate (C18H24O4)	42594-17-2		0.024	mg
Lead Frame	5.85	mg	Supplier	Tin (Sn)	7440-31-5		0.0146	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0129	mg
			Supplier	Chromium (Cr)	7440-47-3		0.0146	mg
			Supplier	Copper (Cu)	7440-50-8		5.8079	mg
Lead Frame plating	0.12	mg	Supplier	Silver (Ag)	7440-22-4		0.12	mg
Mold Compound-Black	14.42	mg		Epoxy resin	proprietary data		0.721	mg
			Supplier	Phenolic Resin	Proprietary Data		0.3317	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		0.721	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0577	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		0.3317	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		12.257	mg
Plating	1.22	mg	Supplier	Tin (Sn)	7440-31-5		1.22	mg
Wire Bond - Au	0.21	mg	Supplier	Gold (Au)	7440-57-5		0.21	mg